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MOSFET - Power, Single N-Channel, DFN5/DFNW5 40 V, 3.7 mΩ, 87 A

NVMFS5C456NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C456NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Parameter Symbol Value Unit V_{DSS} V Drain-to-Source Voltage 40 Gate-to-Source Voltage V_{GS} v ±20 Continuous Drain $T_{\rm C} = 25^{\circ}{\rm C}$ 87 A I_D Current R_{0JC} $T_{\rm C} = 100^{\circ}{\rm C}$ 61 (Notes 1, 3) Steady State $T_C = 25^{\circ}C$ Power Dissipation P_D 55 W $R_{\theta,IC}$ (Note 1) $T_{C} = 100^{\circ}C$ 27 Continuous Drain T_A = 25°C 22 А I_D Current R_{0JA} $T_A = 100^{\circ}C$ 16 (Notes 1, 2, 3) Steady State Power Dissipation w $T_A = 25^{\circ}C$ P_D 3.6 R_{0JA} (Notes 1 & 2) $T_A = 100^{\circ}C$ 1.8 Pulsed Drain Current $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ 520 A IDM °C Operating Junction and Storage Temperature T_J, T_{stg} -55 to + 175 Source Current (Body Diode) 61 А I_S E_{AS} Single Pulse Drain-to-Source Avalanche 202 mJ Energy $(I_{L(pk)} = 5 A)$ Lead Temperature for Soldering Purposes T_{L} 260 °C (1/8" from case for 10 s)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

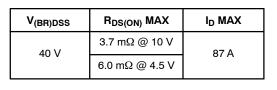
THERMAL RESISTANCE MAXIMUM RATINGS

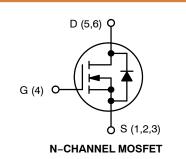
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.7	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	42	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



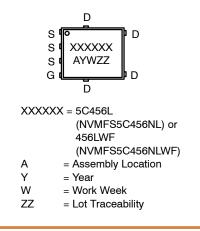




DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

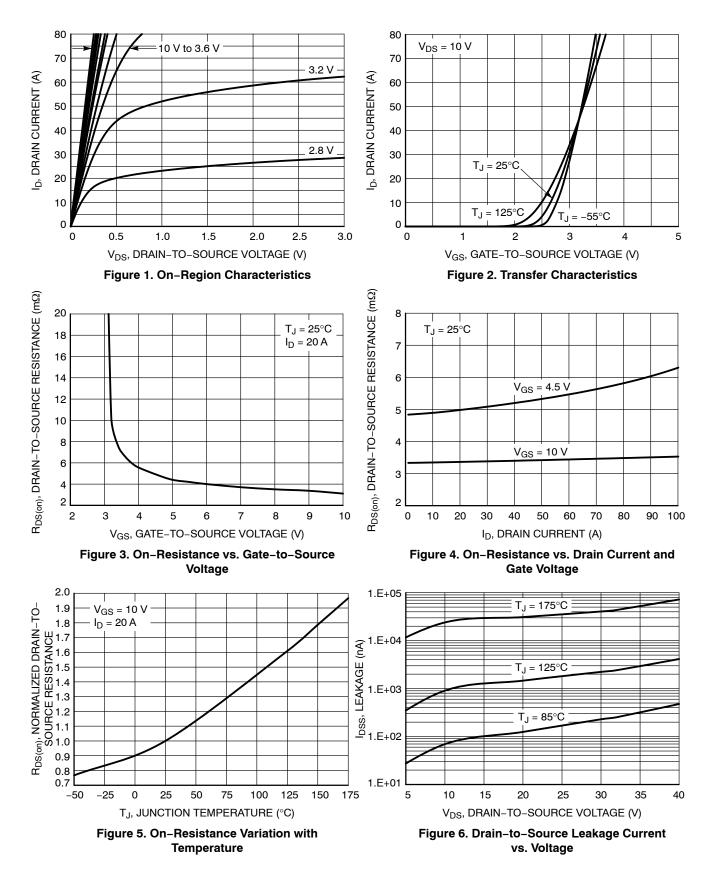
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

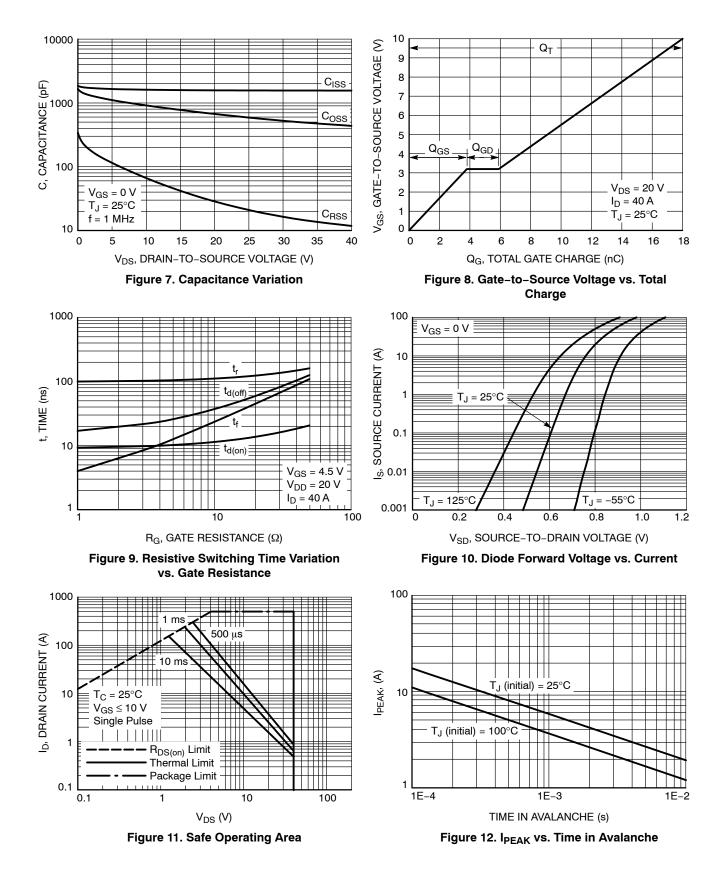
Parameter	Symbol	Test Cond	dition	Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D	= 250 μA	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				22		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10	
		V _{DS} = 40 V	$T_J = 125^{\circ}C$			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _C	_{as} = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 50 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.1		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 20 A		4.8	6.0	mΩ
		V _{GS} = 10 V	I _D = 20 A		3.1	3.7	
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 40 A			80		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1600		pF
Output Capacitance	C _{OSS}				590		
Reverse Transfer Capacitance	C _{RSS}				21		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 20 V; I_{D} = 40 A			18		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 20 V; I _D = 40 A			8.2		nC V
Threshold Gate Charge	Q _{G(TH)}				2		
Gate-to-Source Charge	Q _{GS}				3.8		
Gate-to-Drain Charge	Q _{GD}				2.1		
Plateau Voltage	V _{GP}				3.2		
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t _{d(ON)}				9.3		
Rise Time	tr	V _{CS} = 4.5 V. V	ne = 20 V.		100		1
Turn-Off Delay Time	t _{d(OFF)}	$\begin{array}{l} V_{GS}=\text{4.5 V, } V_{DS}=\text{20 V,} \\ I_{D}=\text{40 A, } R_{G}=\text{1 } \Omega \end{array}$			17		ns
Fall Time	t _f				4		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.86	1.2	
		$V_{GS} = 0 V,$ $I_S = 40 A$	T _J = 125°C		0.75		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 40 A			29		ns
Charge Time	ta				14		
Discharge Time	t _b				15		
Reverse Recovery Charge	Q _{RR}				20		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

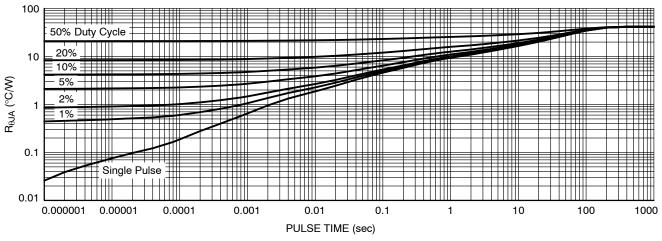


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]	
NVMFS5C456NLT1G	5C456L	DFN5 (Pb–Free)	1500 / Tape & Reel	
NVMFS5C456NLWFT1G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C456NLT3G	5C456L	DFN5 (Pb-Free)	5000 / Tape & Reel	
NVMFS5C456NLWFT3G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	
NVMFS5C456NLAFT1G	5C456L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C456NLAFT1G-YE	5C456L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C456NLWFAFT1G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C456NLWFET1G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C456NLWFET3G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	

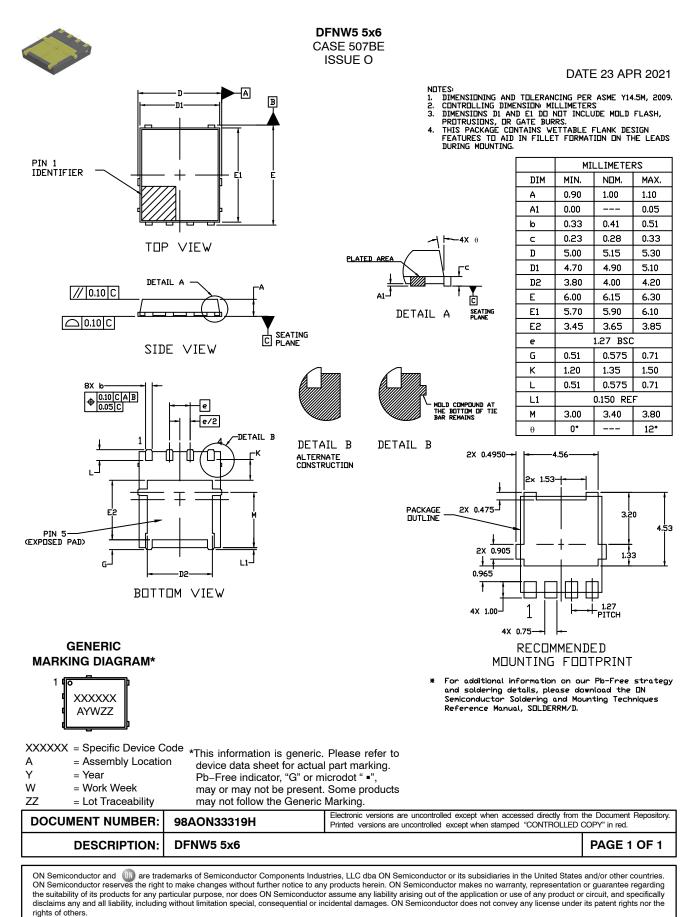
DEVICE ORDERING INFORMATION

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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